



# BC817-16Q /-25Q /-40Q

#### 45V NPN SMALL SIGNAL TRANSISTOR IN SOT23

# Description

This Bipolar Junction Transistor (BJT) is designed to meet the stringent requirements of automotive applications.

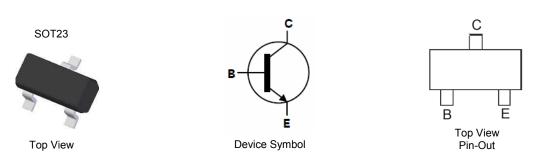
## Features

- BV<sub>CEO</sub> > 45V
- I<sub>C</sub> = 0.5A Continuous Collector Current
- I<sub>CM</sub> = 1A Peak Pulse Current
- Complementary PNP Types: BC807-xxQ
- Ideally Suited for Automatic Insertion
- Epitaxial Planar Die Construction
- For Switching and AF Amplifier Applications
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The BC817-16Q /-25Q/-40Q are suitable for automotive applications requiring specific change control; these parts are AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Weight 0.008 grams (Approximate)



#### Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
BC817-16Q-7-F	Automotive	K6A	7	8	3,000
BC817-25Q-7-F	Automotive	K6B	7	8	3,000
BC817-40Q-7-F	Automotive	K6C	7	8	3,000
BC817-40Q-13-F	Automotive	K6C	13	8	10,000

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**

SOT2	3
XXX	ΥM

XXX = Product Type Marking Code (See Ordering Information) YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: I = 2021)

M = Month (ex: 9 = September)

Date Code Key												
Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2033
Code		J	К	L	М	Ν	0	Р	R	S	Т	U
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



### Absolute Maximum Ratings (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	50	V
Collector-Emitter Voltage	V <sub>CEO</sub>	45	V
Emitter-Base Voltage	V <sub>EBO</sub>	5.0	V
Collector Current	Ic	0.5	А
Peak Pulse Collector Current (single pulse)	I <sub>CM</sub>	1.0	А
Peak Pulse Base Current (single pulse)	I <sub>BM</sub>	200	mA

### Thermal Characteristics (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Dower Discinction	(Note 5)	D	310	mW	
Power Dissipation	(Note 6)	PD	350	TIVV	
Thermal Desistance, lunction to Archient	(Note 5)	P	403	80AM	
Thermal Resistance, Junction to Ambient	(Note 6)	R <sub>0JA</sub>	357	°C/W	
Thermal Resistance, Junction to Leads (Note 7)		R <sub>θJL</sub>	350	°C/W	
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-65 to +150	°C		

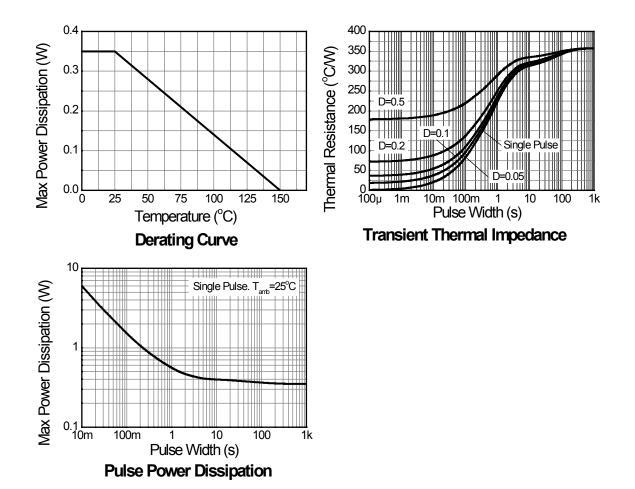
# ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	8,000	V	3B
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes: 5. For a device mounted on minimum recommended pad layout FR-4 PCB with high coverage of single sided 1oz copper; device is measured under still air To a device mounted on minimulative commended paragolar (New FCB with high conditions whilst operating in a steady-state.
Same as Note 5, except mounted on 15mm x 15mm 1oz copper.
Thermal resistance from junction to solder-point (at the end of the collector lead).
Refer to JEDEC specification JESD22-A114 and JESD22-A115.



# Thermal Characteristics and Derating Information





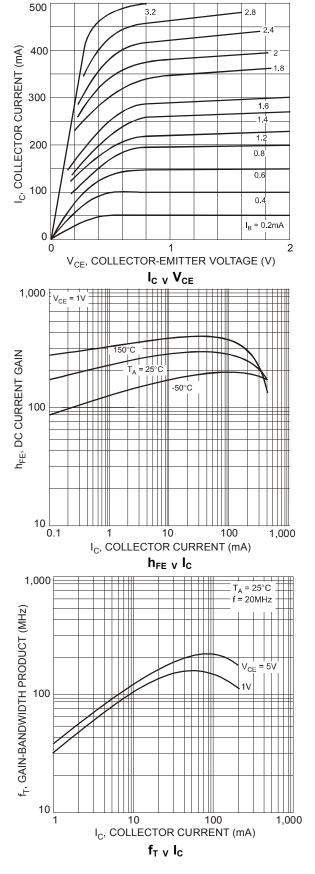
# Electrical Characteristics (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

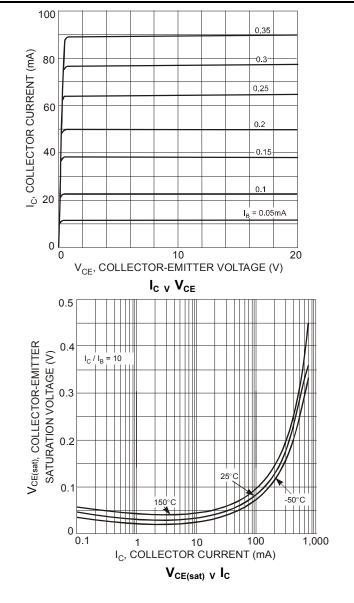
Characterist	ie.	Symbol	Min	Tum	Мах	Unit	Test Condition
Characteristic			Min	Тур	wax	Unit	Test Condition
Collector-Base Breakdown Voltage			50	—	—	V	I <sub>C</sub> = 100μA
Collector-Emitter Breakdown Voltage (	Note 9)	BV <sub>CEO</sub>	45	—		V	I <sub>C</sub> = 10mA
Emitter-Base Breakdown Voltage		BV <sub>EBO</sub>	5	_	_	V	I <sub>C</sub> = 100μΑ
Collector-Emitter Cut-Off Current		I <sub>CES</sub>	_	_	100 5.0	nA μA	V <sub>CE</sub> = 45V V <sub>CE</sub> = 25V, T <sub>J</sub> = +150°C
Emitter-Base Cut-Off Current		I <sub>EBO</sub>	_	_	100	nA	V <sub>EB</sub> = 5.0V
	BC817-16Q BC817-25Q BC817-40Q		100 160 250		250 400 600	_	V <sub>CE</sub> = 1.0V, I <sub>C</sub> = 100mA
DC Current Gain (Note 9)	BC817-16Q BC817-25Q BC817-40Q		60 100 170	_			V <sub>CE</sub> = 1.0V, I <sub>C</sub> = 300mA
Collector-Emitter Saturation Voltage (N	V <sub>CE(sat)</sub>	_	_	0.7	V	I <sub>C</sub> = 500mA, I <sub>B</sub> = 50mA	
Base-Emitter Voltage (Note 9)		V <sub>BE</sub>	_	—	1.2	V	V <sub>CE</sub> = 1.0V, I <sub>C</sub> = 300mA
Transition frequency		f <sub>T</sub>	100	_	—	MHz	V <sub>CE</sub> = 5.0V, I <sub>C</sub> = 10mA, f = 50MHz
Collector-Base Capacitance			_	_	12	pF	V <sub>CB</sub> = 10V, f = 1.0MHz

Note: 9. Measured under pulsed conditions. Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2%.



#### Typical Electrical Characteristics (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

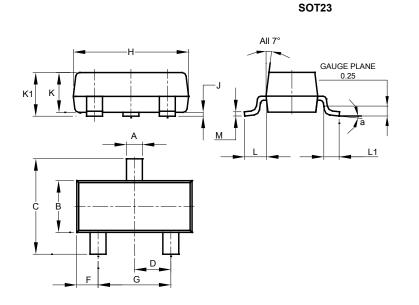






# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

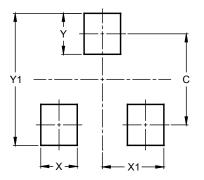


	SOT23							
Dim	Max	Тур						
Α	0.37	0.51	0.40					
в	1.20	1.40	1.30					
С	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78	2.05	1.83					
H	2.80	3.00	2.90					
<b>ر</b>	0.013	0.10	0.05					
ĸ	0.890	1.00	0.975					
K1	0.903	1.10	1.025					
L	0.45	0.61	0.55					
L1	0.25	0.55	0.40					
Μ	0.085	0.150	0.110					
а	0°	8°						
All	All Dimensions in mm							

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)				
С	2.0				
Х	0.8				
X1	1.35				
Y	0.9				
Y1	2.9				



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